

Electronic Acknowledgement Receipt

EFS ID:	1385776
Application Number:	10762789
International Application Number:	
Confirmation Number:	6124
Title of Invention:	Wafer, intermediate wafer assembly and associated method for fabricating a silicon on insulator wafer having an improved edge profile
First Named Inventor/Applicant Name:	Douglas G. Anderson
Customer Number:	826
Filer:	Guy Randall Gosnell/Gwen Frickhoeffter
Filer Authorized By:	Guy Randall Gosnell
Attorney Docket Number:	039035/267930
Receipt Date:	19-DEC-2006
Filing Date:	22-JAN-2004
Time Stamp:	16:07:33
Application Type:	Utility

Payment information:

Submitted with Payment	no
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
1	Response to Election / Restriction Filed	267930.pdf	52603	no	1

Warnings:

Information:	
Total Files Size (in bytes):	52603
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